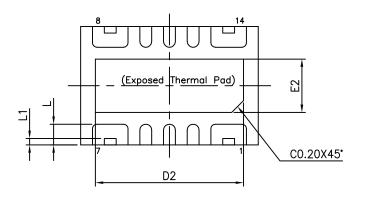
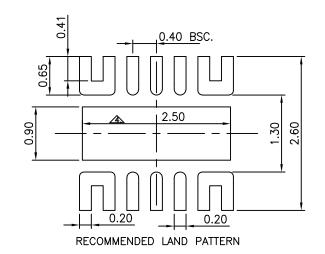


SYMBOLS	MIN.	NOM.	MAX.
Α	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	0.203 REF.		
b	0.15	0.20	0.25
D	2.90	3.00	3.10
E	1.90	2.00	2.10
D2	2.40	2.50	2.60
E2	0.80	0.90	1.00
е	0.40 BSC		
L	0.30	0.35	0.40
L1	0.06	0.11	0.16





Notes:

- 1. All dimensions are in mm. Angles in degrees.
- 2. Coplanarity applies to the exposed thermal pads as well as the terminals.
- 3. Recommended land pattern is for reference only.
- 4. Thermal pad soldering area (Mesh stencil is recommended)



DESCRIPTION: 14-Lead, Thin Dual-in-line Flat No-Lead (TDFN)

PACKAGE CODE: ZJ14

DOCUMENT CONTROL #: PD - 2159

DATE: 06/10/13

REVISION: -